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APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO. 09/020.565 01/16/98 J LYDING 22010-128/IL **EXAMINER** MM42/0727 KENNETH A GANDY WOODARD EMHARDT LEE,H NAUGHTON MORIARTY AND MCNETT **ART UNIT** PAPER NUMBER BANK ONE TOWER SUITE 3700 111 MONUMENT CIRCLE 2823 INDIANAPOLIS IN 46204-5137

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

07/27/99

Office Action Summary

Application No. 09/020,565

Applicant(s)

Lyding et al.

Examiner

Hsien-Ming Lee

Group Art Unit 2823



Responsive to communication(s) filed on Aug 3, 1998	<u> </u>
This action is FINAL .	
Since this application is in condition for allowance except for forms in accordance with the practice under Ex parte Quayle, 1935 C.D.	al matters, prosecution as to the merits is closed 11; 453 O.G. 213.
A shortened statutory period for response to this action is set to expire solutions from the mailing date of this communication. Failure to respond application to become abandoned. (35 U.S.C. § 133). Extensions of 37 CFR 1.136(a).	pond within the period for response will cause the
Disposition of Claims	
X Claim(s) 1-14 and 28-35	is/are pending in the application.
Of the above, claim(s)	is/are withdrawn from consideration.
Claim(s)	is/are allowed.
	is/are rejected.
☐ Claim(s)	
☐ Claims	are subject to restriction or election requirement.
Application Papers X See the attached Notice of Draftsperson's Patent Drawing Revi The drawing(s) filed on is/are objected to	
☐ The proposed drawing correction, filed on	
☐ The specification is objected to by the Examiner.	
\square The oath or declaration is objected to by the Examiner.	
Priority under 35 U.S.C. § 119 Acknowledgement is made of a claim for foreign priority under All Some* None of the CERTIFIED copies of the preceived. received in Application No. (Series Code/Serial Number)	priority documents have been
$\hfill\Box$ received in this national stage application from the Intern	national Bureau (PCT Rule 17.2(a)).
*Certified copies not received: Acknowledgement is made of a claim for domestic priority und	
	161 30 0.0.0. 3 1 10(0).
Attachment(s) Notice of References Cited, PTO-892 Information Disclosure Statement(s), PTO-1449, Paper No(s). Interview Summary, PTO-413 Notice of Draftsperson's Patent Drawing Review, PTO-948 Notice of Informal Patent Application, PTO-152	5
SEE OFFICE ACTION ON THE F	OLLOWING PAGES

DETAILED ACTION

Specification

- The disclosure is objected to because of the following informalities:
 In specification, page 12, line 7, "the device 12" should be --the device 11--.
 Appropriate correction is required.
- 2. The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.
- 3. The following title is suggested: A Method of Forming Semiconductor Devices Comprising Deuterium Anneal for Improved Hot Carrier Reliability.

Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless --

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 5. Claims 1-14, 28-31, 33-35 rejected under 35 U.S.C. 102(b) as being anticipated by Lisenker et al., National Semiconductor (submitted by applicant).

See page 4, line 19 through page 5, line 29; page 6, lines 10-36; page 7, lines 25-29; page 8, line 29 through page 9, line 25; page 10, line 26 through page 11, line 22; page 12-14.

Application/Control Number: 09/020,565 Page 3

Art Unit: 2823

Lisenker et al. teach the claimed method for conditioning a semiconductor device to increase its resilience to hot carrier effects, comprising passivating the device with molecular deuterium comprises deuterium gas and nitrogen (page 4, line 30; page 8, line 29 through page 9, line 1; and page 9, lines 15-25) in an area of the device subject to hot carrier effects; and heating the device (page 4, line 30); wherein the semiconductor device includes a silicon layer and an insulative layer (silicon oxide) adjacent the silicon layer (page 6, lines 32-35); the deuterium ambient includes 1% to 100% by volume deuterium gas (page 14, claim 17); heating the device at a temperature of about 500C in a deuterium ambient (page 9, lines 15-22); and the device includes at least one metal oxide semiconductor (MOS) transistor (page 11, lines 5-8).

Claim Rejections - 35 USC § 103

- 6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 7. Claim 32 is rejected under 35 U.S.C. 103(a) as being unpatentable over Lisenker et al. as applied to claim 28 above, and further in view of Brown et al. (submitted by applicant).

Lisenker et al. disclose substantially the claimed method of conditioning a semiconductor device to increase its resilience to hot carrier effects, comprising disposing deuterium in an area of the device subject to hot carrier effects, and heating the device (see page 4, line 19 through

page 5, line 29; page 6, lines 10-36; page 7, lines 25-29; page 8, line 29 through page 9, line 25; page 10, line 26 through page 11, line 22; page 12-14) with the exception of including a silicon nitride layer in the device.

However, Brown et al. (submitted by applicant) teach the utilization of silicon nitride layer in a semiconductor device, particularly in a metal oxide semiconductor (MOS), as a dielectric layer due to its higher dielectric constant.

Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention to include a silicon nitride layer as taught by Brown (see col. 1, lines 9-23) in the semiconductor device as taught by Lisenker to improve the reliability of the device, since this combination would result in the advantages of the imperviousness to water vapor and ion diffusion, and radiation shielding.

- 8. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.
- * Park et al. (submitted by applicant; title: The Effect of Annealing Treatment on the Distribution of Deuterium in Silicon and Silicon/Silicon Oxide Systems) teach the passivation of Si/SiO₂ structure for the application of MOS through deuterium-anneal process.
- * Saks et al. (submitted by applicant; title: Time-dependence of the interface trap build-up in deuterium-annealed oxides after irradiation) teach that MOS device was processed incorporate with deuterium by annealing.

Application/Control Number: 09/020,565

Art Unit: 2823

* Myers et al. (submitted by applicant; title: Interactions of deuterium with ion-irradiated ${
m SiO_2}$

Page 5

on Si) teach the utilization of deuterium-anneal for MOS.

Any inquiry concerning this communication or earlier communications from the examiner 9.

should be directed to Hsien-Ming Lee whose telephone number is (703) 305-7341. The

examiner can normally be reached on Monday-Friday from 7:30 AM to 4:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Wael Fahmy, can be reached on (703) 308-4918. The fax phone number for this

Group is (703) 305-3432.

Any inquiry of a general nature or relating to the status of this application or proceeding

should be directed to the Group receptionist whose telephone number is (703) 308-0956.

Supervisory Patent Examiner

Technology Center 2809

Hsien-Ming Lee

Examiner Group 2823

July 23, 1999, c:\09-020565-1